## SN5495A, SN54LS95B, SN7495A. SN74LS95B 4-BIT PARALLEL-ACCESS SHIFT REGISTERS

MARCH 1974 - REVISED MARCH 1988

TYPE	TYPICAL MAXIMUM	TYPICAL
'95A	CLOCK FREQUENCY 36 MHz	POWER DISSIPATION 195 mW
'L\$95B	36 MHz	65 mW

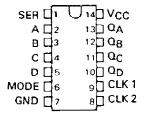
#### description

These 4-bit registers feature parallel and serial inputs, parallel outputs, mode control, and two clock inputs. The registers have three modes of operation:

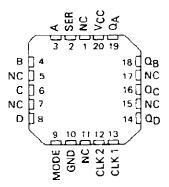
Parallel (broadside) load Shift right (the direction Q<sub>A</sub> toward Q<sub>D</sub>) Shift left (the direction QD toward QA)

Parallel loading is accomplished by applying the four bits of data and taking the mode control input high. The data is loaded into the associated flip flops and appears at the outputs after the high-to-low transition of the clock-2 input. During loading, the entry of serial data is inhibited.

Shift right is accomplished on the high-to-low transition of clock 1 when the mode control is low; shift left is accomplished on the high-to-low transition of clock 2 when the mode control is high by connecting the output of each flip-flop to the parallel input of the previous flip-flop (QO to input C, etc.) and serial data is entered at input D. The clock input may be applied commonly to clock 1 and clock 2 if both modes can be clocked from the same source. Changes at the mode control input should normally be made while both clock inputs are low; however, conditions described in the last three lines of the function table will also ensure that register contents are protected. SN5495A, SN54LS95B . . . J OR W PACKAGE SN7495A . . . N PACKAGE SN74LS95B . . . D OR N PACKAGE (TOP VIEW)



SN54LS95B . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

#### **FUNCTION TABLE**

	INPUTS								OUT	PUTS	
MODE	CFO	CKS	CERIAL	PARALLEL				٥.	0-	0.0	α <sub>D</sub>
CONTROL	2 (L)	1 (R)	SERIAL	Α	В	С	D	QΦ	σB	σc	<u>40</u>
Н	Н	X	Х	, ×	X	х	X	Q <sub>AO</sub>	аво	$a_{CO}$	$\sigma^{\mathrm{D}0}$
Н		X	×	a	ь	c	đ	а	b	С	đ
н	1	×	×	QBt	Q <sub>C</sub> †	a <sub>D</sub> t	d	a <sub>Bn</sub>	$a_{Cu}$	$Q_{Dn}$	đ
L	L	Н	×	x	X	X	X	O <sub>A</sub> O	$\sigma_{BO}$	$a_{CO}$	$\sigma_{DO}$
L	×	ţ	н	x	х	Х	х	н	$\alpha_{An}$	O <sub>Bn</sub>	$\alpha_{Cn}$
L	×	ţ	L	×	X	Х	x	L	$Q_{An}$	QBn	$\alpha_{Cn}$
Ť	L	Ł	×	x	Х	х	X	QAO	$\alpha_{BO}$	$a_{co}$	$\sigma_{D0}$
ı	L	L	×	x	x	х	х	Q <sub>A</sub> O	α <sub>B0</sub>	$\alpha_{CO}$	$a_{D0}$
1	<u> </u>	н	×	×	х	х	X	Q <sub>A</sub> O	$\sigma^{BO}$	$\sigma^{\text{CO}}$	$a_{D0}$
f	Н	Ļ	×	X	х	х	×	QAD	$\alpha_{BO}$	$\sigma^{co}$	$\sigma^{\text{DO}}$
<b>†</b>	н	н	×	×	X	X	x	QAO	$\alpha_{BO}$	$\Omega_{CO}$	000

<sup>1</sup>Shifting left requires external connection of  $\Omega_{B}$  to A,  $\Omega_{C}$  to B, and  $\Omega_{D}$  to C. Serial data is entered at input D. H= high level (steady state), L= low level (steady state), X= irrelevant (any input, including transitions)

L = transition from high to low level, T = transition from low to high level

a, b, c, d = the level of steady-state input at inputs A, B, C, or D, respectively.

 $Q_{A0}$ ,  $Q_{B0}$ ,  $Q_{C0}$ ,  $Q_{D0}$  = the level of  $Q_{A}$ ,  $Q_{B}$ ,  $Q_{C}$ , or  $Q_{D}$ , respectively, before the indicated steady-state input conditions were established.

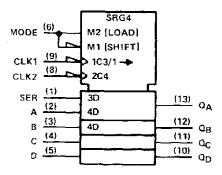
QAn, QBn, QCn, QOn = the level of QA, QB, QC, or QD, respectively, before the most-recent I transition of the clock

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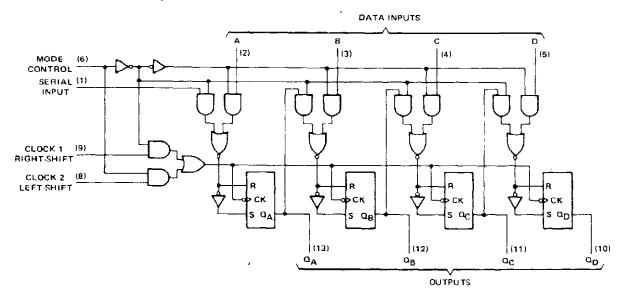
# SN5495A, SN54LS95B, SN7495A, SN74LS95B 4-BIT PARALLEL-ACCESS SHIFT REGISTERS

#### logic symbol<sup>†</sup>



 $<sup>^{\</sup>dagger}$  This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

#### logic diagram (positive logic)



# schematics of inputs and outputs TYPICAL OF ALL OUTPUTS **EQUIVALENT OF EACH INPUT** INPUT OUTPUT Mode control: $R_{eq} = 3 k\Omega NOM$ Clock inputs: $R_{eq} = 4 k\Omega NOM$ '95A' R 100 Ω 'L95: R = 500 \O All other inputs: Req = 6 kW NOM 'L\$958 'L\$958 'LS95B TYPICAL OF ALL OUTPUTS **EQUIVALENT OF CLOCK EQUIVALENT OF DATA** AND MODE CONTROL INPUTS AND SERIAL INPUTS 120 Ω NOM 17 $\Omega$ NOM 15 kΩ NOM INPUT-OUTPUT

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

	SN54*	SN54LS	SN74"	SN74LS	UNIT	
Supply voltage, V <sub>CC</sub> (see Note 1)	7	7	7	7	V	
Input voltage	5.5	7	5.5	7	V	
Interemitter voltage (see Note 2)	5.5		5.5		V	
Operating free-air temperature range	- 55	to 125	0 to 70		°C	
Storge temperature range	- 65	-65 to 150		-65 to 150		

- NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.
  - 2. This is the voltage between two emitters of a multiple-emitter input transistor. This rating applies between the clock-2 input and the mode control input of the '95A.

### SN5495A, SN7495A 4-BIT PARALLEL-SHIFT REGISTERS

#### recommended operating conditions

		SN5495A			SN7495A		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			-800			-800	μА
Low-level output current, IOL			16		_	16	mA
Clock frequency, f <sub>clock</sub>	0		25	0		25	MHz
Width of clock pulse, tw(clock) (See Figure 1)	20			20			ns
Setup time, high-level or low-level data, t <sub>SU</sub> (See Figure 1)	15			15			ns
Hold time, high-level or low-level data, th (See Figure 1)	0			0			ns
Time to enable clock 1, t <sub>enable</sub> 1 (See Figure 2)	15			15			ns
Time to enable clock 2 (See Figure 2)	15			15			กร
Time to inhibit clock 1, tinhibit 1 (See Figure 2)	5			5			ns
Time to inhibit clock 2, t <sub>inhibit 2</sub> (See Figure 2)	5			5			пз
Operating free-air temperature, TA	-55		125	0		70	°C

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST SOURIFICANT		SN5495	Д		UNIT			
		TEST CONDITIONS <sup>†</sup>	MIN	MIN TYP# MAX		MIN	TYP‡	MAX	UNII	
ViH	High-level input vol	tage		2			2			V
VIL	Low-level input vol	tage		1	<u></u>	8.0			0.8	V
VIK	Input clamp voltage	?	V <sub>CC</sub> = MIN, I <sub>I</sub> = -12 mA			-1.5			-1.5	V
Voн	High-level output voltage		V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = -800 μA	2.4	3.4		2.4	3.4		v
VoL	Low-level output voltage		V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 16 mA		0.2	0.4		0.2	0.4	v
I <sub>t</sub>	Input current at maximum input voltage		V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V			1			1	mA
Ън	High-level	Serial, A, B, C, D, Clock 1 or 2	V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.4 V			40			40	μΑ
	input current	Mode control	1			80			80	]
Iιε	input current	Serial, A, B, C, D, Clock 1 or 2	V <sub>CC</sub> = MAX, V <sub>1</sub> = 0.4 V			1,6			-1.6	mΑ
		Mode control				-3.2			-3.2	
los	Short-circuit output current§		V <sub>CC</sub> = MAX	-18		-57	-18		-57	mA
icc	Supply current		V <sub>CC</sub> = MAX, See Note 3		39	63		39	63	mΑ

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

### switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f <sub>max</sub> Maximum clock frequency	$C_1 = 15  \text{pF},  R_1 = 400  \Omega,$	25	36		MHZ
tpLH Propagation delay time, low-to-high-level output from clock	See Figure 1		18	27	ns
tpHL Propagation delay time, high-to-low-level output from clock	1 See rigure 1		21	32	ns



 $<sup>^{\</sup>circ}$  All typical values are at  $V_{CC} = 5$  V,  $T_{A} = 25$  °C.

 $<sup>^{\</sup>S}$  Not more than one output should be shorted at a time.

NOTE 3: ICC is measured with all outputs and serial input open; A, B, C, and D inputs grounded; mode control at 4.5 V; and a momentary 3 V, then ground, applied to both clock inputs.

### recommended operating conditions

	SI	SN54LS95B			SN74LS95B		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			<del>-4</del> 00			-400	μА
Low-level output current, IOL			4	<u> </u>		8	mA
Clock frequency, f <sub>clock</sub>	0		25	0		25	MHz
Width of clock pulse, tw(clock) (see Figure 1)	20			20			ns
Setup time, high-level or low-level data, t <sub>SU</sub> (see Figure 1)	20			20			ns
Hold time, high-level or low-level data, th (see Figure 1)	20			10			ns
Time to enable clock 1, tenable 1 (see Figure 2)	20			20			ns.
Time to enable clock 2, tenable 2 (see Figure 2)	20			20			ns
Time to inhibit clack 1, tinhibit 1 (see Figure 2)	20			20			ns
Time to inhibit clock 2, tinhibit 2 (see Figure 2)	20			20			กร
Operating free-air temperature, TA	-55		125	0		70	°C_

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				SN54LS95B		Sf	58	UNIT		
	PARAMETER	TEST CON	TEST CONDITIONS		MIN TYPI		MIN	TYP <sup>‡</sup>	MAX	UNII
VIH	High-level input voltage			2			2			V
VIL	Low-level input voltage					0.7			8.0	٧
ViK	Input clamp voltage	V <sub>CC</sub> = MIN,	I <sub>I</sub> '= -18 mA			-1.5			1.5	V
VOH	High-level output voltage	V <sub>CC</sub> = MtN, V <sub>1L</sub> - V <sub>1L</sub> max,	V <sub>IH</sub> = 2 V, I <sub>OH</sub> = -400 μA	2.5	3.4		2.7	3.4		V
	Low-level autput voltage	V <sub>CC</sub> = MIN,	IOL = 4 mA		0.25	0.4		0.25	0.4	
VOL		V <sub>1H</sub> = 2 V, V <sub>IL</sub> = V <sub>IL</sub> max	1 <sub>OL</sub> = 8 mA					0.35	0.5	
I <sub>k</sub>	Input current at maximum input voltage	V <sub>CC</sub> = MAX.	V <sub>1</sub> = 7 V		_	0.1			0.1	mΑ
чн	High-level input current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V			20			20	μА
IIE	Low-level input current	V <sub>CC</sub> - MAX	V <sub>1</sub> = 0.4 V			_0. <b>4</b>			-0.4	mA
los	Short-circuit output current 5	V <sub>CC</sub> = MAX		-20		-100	-20		100	mΑ
Icc	Supply current	VCC = MAX.	See Note 3		13	21	Ι	13	21	mΑ

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

### switching characteristics, VCC = 5 V, TA = 25°C

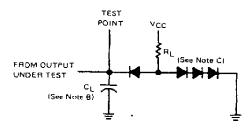
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f <sub>max</sub> Maximum clock frequency	$C_1 = 15  \text{pF},  R_1 = 2  \text{k}\Omega$	25	36		MHz
tpeH Propagation delay time, low-to-high-level output from clock	See Figure 1		18	27	ns
tpHL Propagation delay time, high-to-low-level output from clock		<u> </u>	21	32	ns

<sup>\*</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25 \, ^{\circ}\text{C}$ .

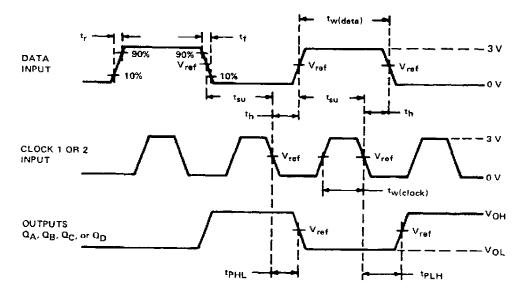
<sup>§</sup> Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 3: ICC is measured with all outputs and serial input open; A, B, C, and D inputs grounded; mode control at 4.5 V; and a momentary 3 V. then ground, applied to both clock inputs.

## PARAMETER MEASUREMENT INFORMATION



#### LOAD CIRCUIT

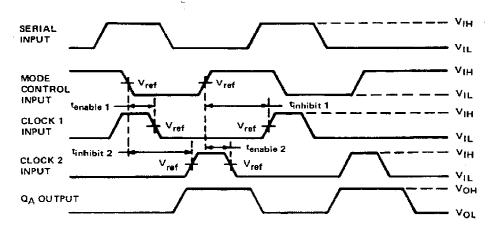


- NOTES: A. Input pulses are supplied by a generator having the following characteristics:  $t_r \le 10$  ns,  $t_t \le 10$  ns, and  $Z_{out} \approx 50 \,\Omega$ . For the data pulse generator, PRR = 500 kHz; for the clock pulse generator, PRR = 1 MHz. When testing  $f_{max}$ , vary PRR. For '95A,  $t_{w(data)} \ge 20$  ns,  $t_{w(clock)} \ge 15$  ns.
  - 8. Ct includes probe and jig capacitance.
  - C. All diodes are 1N3064 equivalent.
  - D. For '95A,  $V_{ref}$  = 1.5 V; for 'LS95B,  $V_{ref}$  = 1.3 V.

VOLTAGE WAVEFORMS FIGURE 1-SWITCHING TIMES

### SN5495A, SN54LS95B, SN7495A, SN74LS95B 4-BIT PARALLEL-ACCESS SHIFT REGISTERS

### PARAMETER MEASUREMENT INFORMATION



NOTES: A. Input is at a low level.

B. For '95A,  $V_{ref}$  = 1.5 V; for 'LS958,  $V_{ref}$  = 1.3 V.

VOLTAGE WAVEFORMS
FIGURE 2 CLOCK ENABLE/INHIBIT TIMES

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